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SMP80MC

Trisil™ for telecom equipment protection

Features

- Bidirectional crowbar protection
- Voltage: range from 120 V to 320 V
- Low V_{BO} / V_R ratio
- Micro capacitance equal to 12 pF @ 50 V
- Low leakage current: I_B = 2 µA max
- Holding current: I_H = 150 mA min.
- Repetitive peak pulse current: $I_{PP} = 80 \text{ A} (10/1000 \mu\text{s})$

Benefits

- Trisils are not subject to ageing and provide a fail safe mode in short circuit for better protection.
- Helps equipment meet main standards such as UL60950, IEC 950 / CSA C22.2 and UL1459.
- Epoxy meets UL94, V0.
- Package is JEDEC registered (DO-214AA).

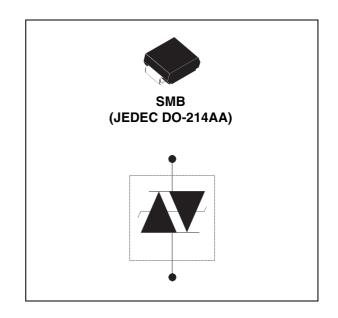
Complies with the following standards

- GR-1089 Core
- ITU-T-K20/K21
- IEC 61000-4-5
- TIA/EIA IS-968
- UL497B recognized, UL file E136224

Applications

Any sensitive equipment requiring protection against lightning strikes and power crossing:

Terminals (phone, fax, modem...) and central office equipment



Description

The SMP80MC is a series of micro capacitance transient surge arrestors designed for the protection of high debit rate communication equipment. Its micro capacitance avoids any distortion of the signal and is compatible with digital transmission like ADSL2 and ADSL2+.

TM: Trisil is a trademark of STMicroelectronics.

Characteristics SMP80MC

1 Characteristics

Table 1. In compliance with the following standards

Standard	Peak surge voltage (V)	Waveform voltage	Required peak current (A)	Current waveform	Minimum serial resistor to meet standard (Ω)	
GR-1089 Core First level	2500 1000	2/10 μs 10/1000 μs	500 100	2/10 μs 10/1000 μs	5 2.5	
GR-1089 Core Second level	5000	2/10 μs 500		2/10 µs	10	
GR-1089 Core Intra-building	1500	2/10 µs	100	2/10 µs	0	
ITU-T-K20/K21	(21 6000 1500 10/700 μs 150 5/310 μ		5/310 µs	10 0		
ITU-T-K20 (IEC61000-4-2)	8000 15000	1/60 ns	ESD contact discharge ESD air discharge		0	
IEC61000-4-5	4000 4000	10/700 μs 1.2/50 μs	100 100	5/310 μs 8/20 μs	0	
TIA/EIA IS-968, lightning surge type A	1500 800	10/160 μs 10/560 μs	200 100	10/160 μs 10/560 μs	2.5 0	
TIA/EIA IS-968, lightning surge type B		9/720 µs	25	5/320 µs	0	

SMP80MC Characteristics

Table 2. Absolute ratings ($T_{amb} = 25 \,^{\circ}C$)

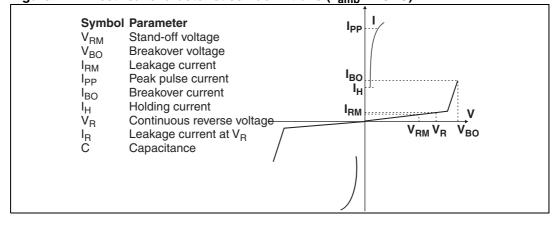
Symbol	Parameter	Conditions	Value	Unit
Ірр	Repetitive peak pulse current (see Figure 2)	10/1000 µs 8/20 µs 10/560 µs 5/310 µs 10/160 µs 1/20 µs 2/10 µs	80 200 100 120 150 200 250	А
I _{FS}	Fail-safe mode: maximum current (1)	8/20 µs	5	kA
ITSM	Non repetitive surge peak on-state current (sinusoidal)	t = 0.2 s t = 1 s t = 2 s t = 15 mn	14 8 6.5 2	A
l ² t	I ² t value for fusing	t = 16.6 ms t = 20 ms	7.5 7.8	A ² s
T _{stg}	Storage temperature range	-55 to 150	°C	
T _j	Operating junction temperature range	-40 to 150		
T_L	Maximum lead temperature for soldering during 10 s. 26			

^{1.} In fail safe mode the device acts as a short circuit.

Table 3. Thermal resistances

Symbol	Parameter	Value	Unit
R _{th(j-a)}	Junction to ambient (with recommended footprint)	100	°C/W
R _{th(j-l)}	Junction to leads	20	°C/W

Figure 1. Electrical characteristics - definitions ($T_{amb} = 25$ °C)



Characteristics SMP80MC

Table 4. Electrical characteristics - values ($T_{amb} = 25$ °C)

	I _{RM} @ V _{RM} I _R @ '		V _R	Dynamic VBO Static VBO @ IBO (2)			IH ⁽³⁾	C ⁽⁴⁾	C ⁽⁵⁾	
Types	max.		max.		max.	max.	max.	min.	typ.	typ.
	μΑ	V	μΑ	٧	V	٧	mA	mA	pF	рF
SMP80MC-120		108		120	155	155				
SMP80MC-140		126		140	180	180				
SMP80MC-160		144		160	205	205				
SMP80MC-200	2	180	5	200	255	255	800	150	12	25
SMP80MC-230		207		230	295	295				
SMP80MC-270		243		270	345	345				
SMP80MC-320		290		320	400	400				

^{1.} See Figure 10: Test circuit 1 for dynamic I_{BO} and V_{BO} parameters

^{2.} See Figure 11: Test circuit 2 for I_{BO} and V_{BO} parameters

^{3.} See Figure 12: Test circuit 3 for dynamic I_H parameter

^{4.} $V_R = 50 \text{ V bias}, V_{RMS} = 1 \text{ V}, F = 1 \text{ MHz}$

^{5.} $V_R = 2 V \text{ bias}, V_{RMS} = 1 V, F = 1 MHz$

SMP80MC Characteristics

Figure 2. Pulse waveform

PP Repetitive peak pulse current tr = rise time (μs) tp = pulse duration time (μs)

Figure 3. Non repetitive surge peak on-state current versus overload duration

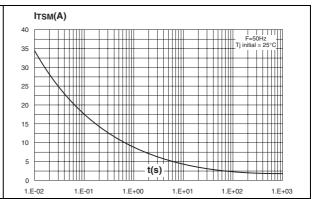
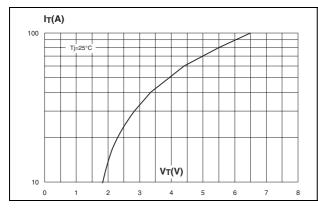


Figure 4. On-state voltage versus on-state current (typical values)

Figure 5. Relative variation of holding current versus junction temperature



IH[Tj] / IH[Tj=25°C]

2.0

1.8

1.6

1.4

1.2

1.0

0.8

0.6

0.4

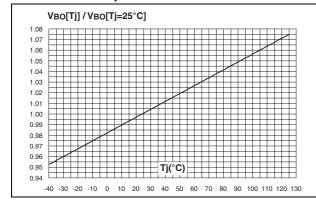
0.2

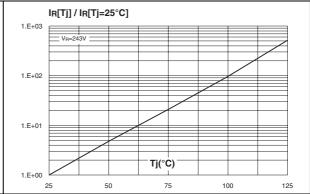
0.0

-40 -30 -20 -10 0 10 20 30 40 50 60 70 80 90 100 110 120 130

Figure 6. Relative variation of breakover voltage versus junction temperature

Figure 7. Relative variation of leakage current versus junction temperature (typical values)





Characteristics SMP80MC

Figure 8. Variation of thermal impedance junction to ambient versus pulse duration

Figure 9. Relative variation of junction capacitance versus reverse voltage applied (typical values)

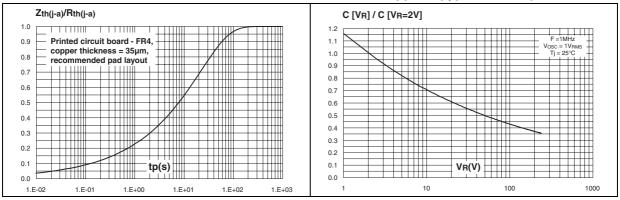
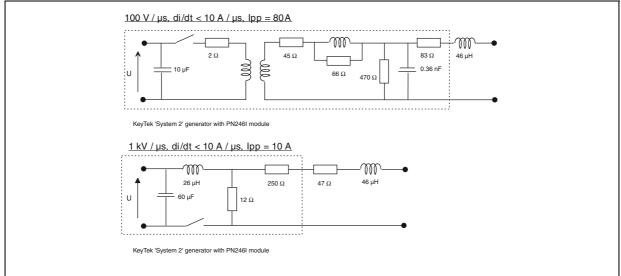


Figure 10. Test circuit 1 for dynamic I_{BO} and V_{BO} parameters



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SMP80MC Characteristics

Figure 11. Test circuit 2 for I_{BO} and V_{BO} parameters

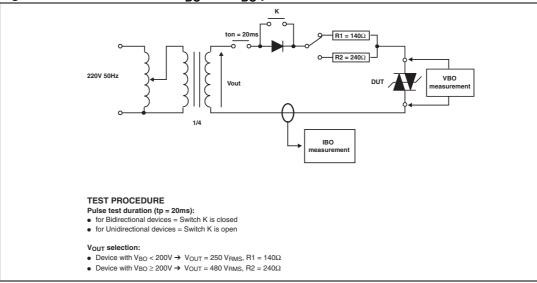
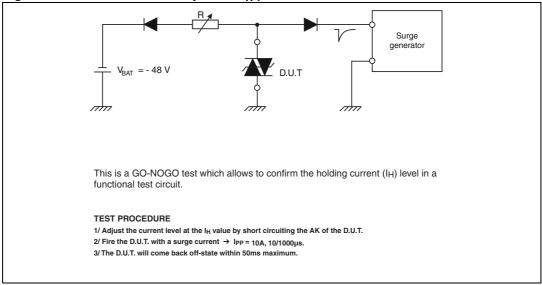
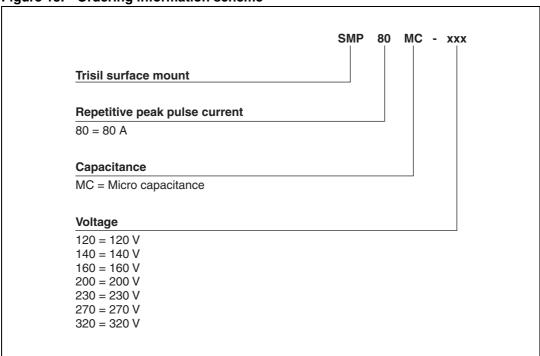


Figure 12. Test circuit 3 for dynamic I_H parameter



2 Ordering Information Scheme

Figure 13. Ordering information scheme



SMP80MC Package information

3 Package information

- Epoxy meets UL94, V0
- Lead-free package

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK[®] packages, depending on their level of environmental compliance. ECOPACK[®] specifications, grade definitions and product status are available at: www.st.com. ECOPACK[®] is an ST trademark.

Table 5. SMB dimensions

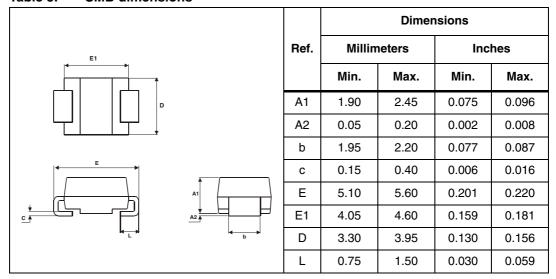
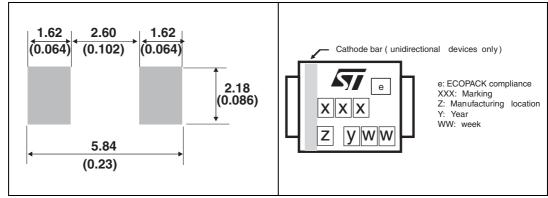


Figure 14. Footprint dimensions in mm (inches)

Figure 15. Marking layout⁽¹⁾



1. Marking layout can vary according to assembly location.

Ordering information SMP80MC

4 Ordering information

Table 6. Ordering information

Part Number	Marking	Package	Weight	Base qty	Delivery mode
SMP80MC-120	TP12				
SMP80MC-140	TP14				
SMP80MC-160	TP16				
SMP80MC-200	TP20	SMB	98 mg	2500	Tape and reel
SMP80MC-230	TP23				
SMP80MC-270	TP27				
SMP80MC-320	TP32				

5 Revision history

Table 7. Document revision history

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Date	Revision Changes				
September-2001	1	First issue.			
11-May-2005	2	New types introduction.			
20-Jun-2005	3	Qualification of new types			
18-Jan-2007	4	Added product SMP80MC-320			
09-Feb-2012	5	Added UL statement in Complies with the following standards			

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